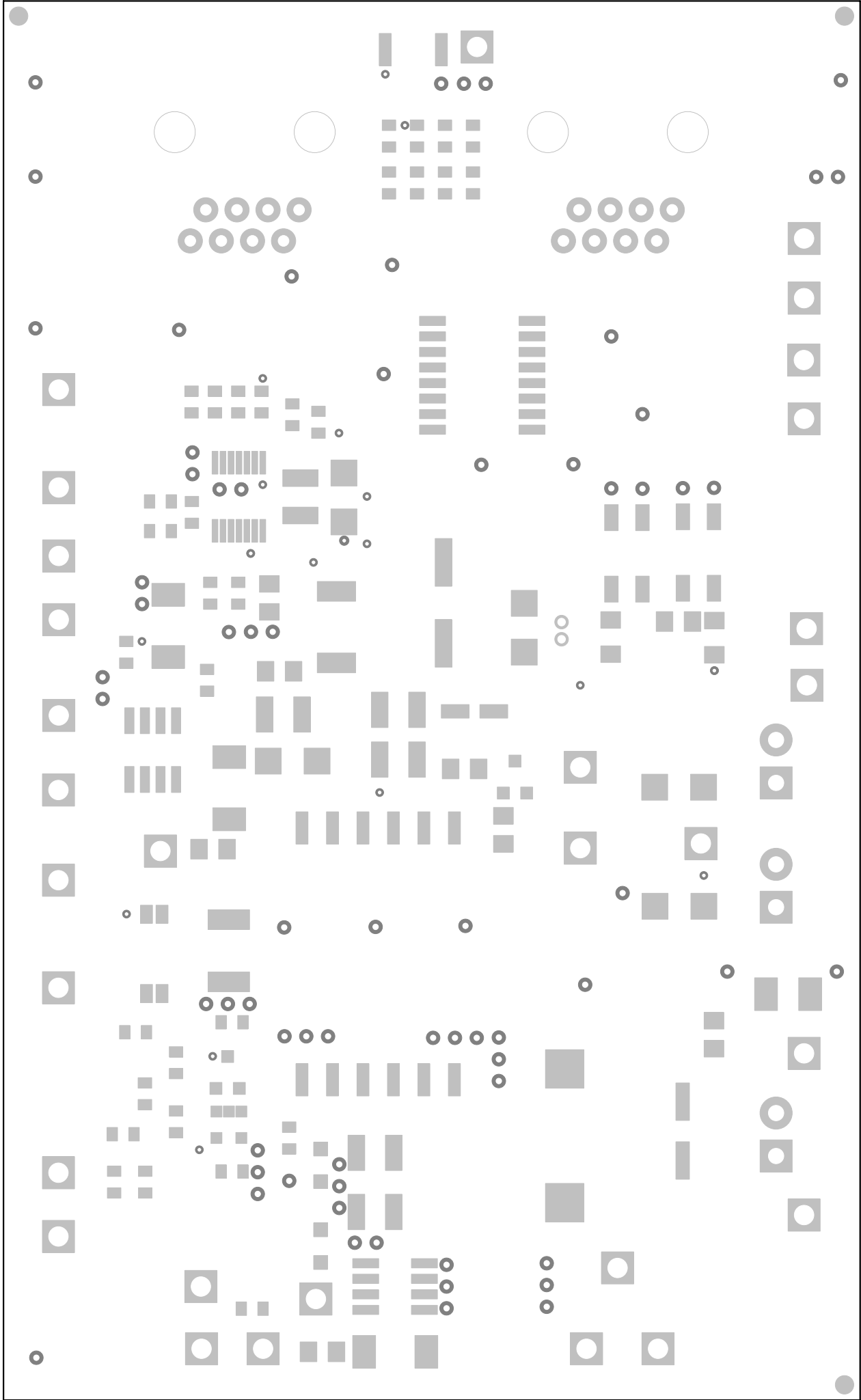
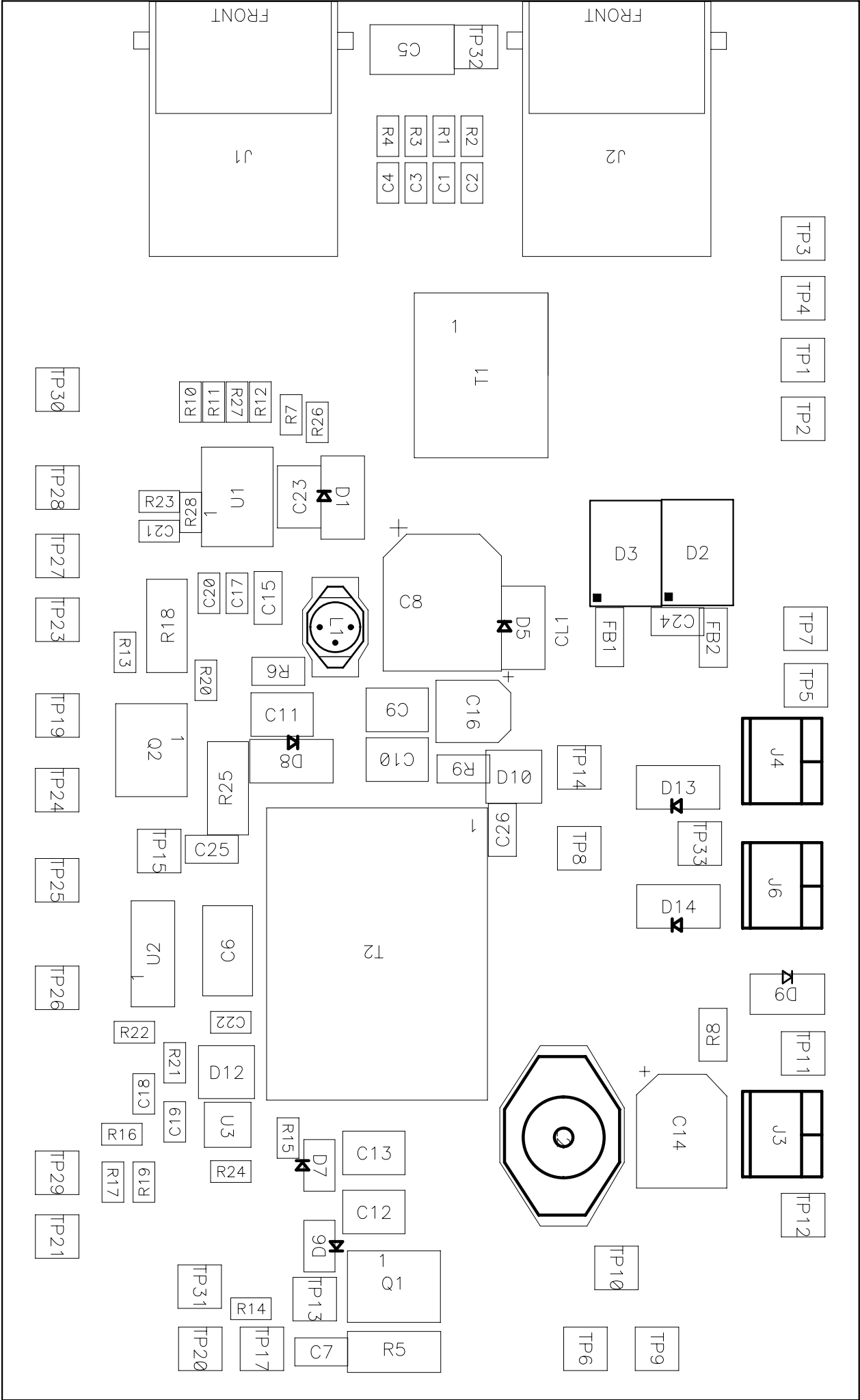
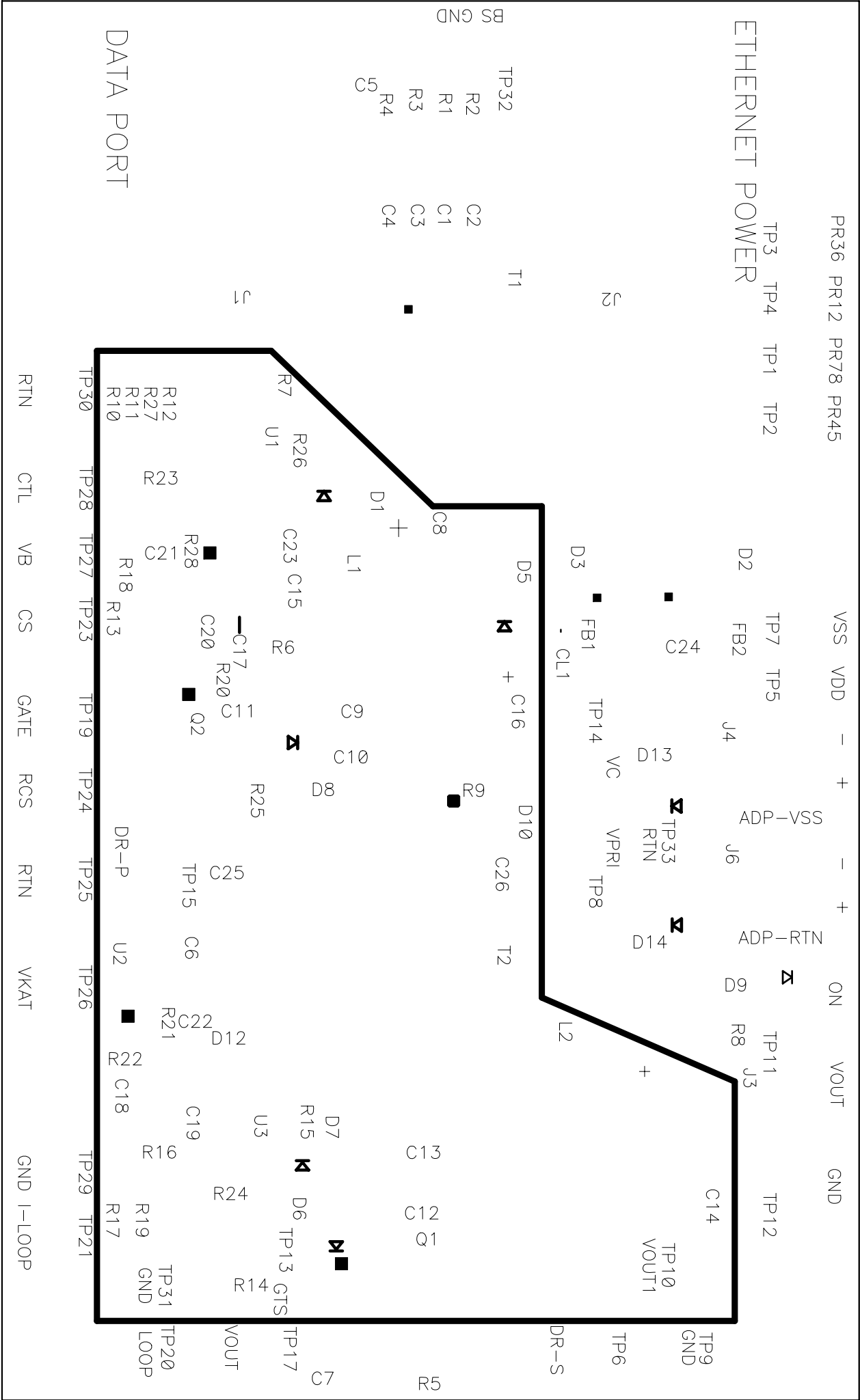


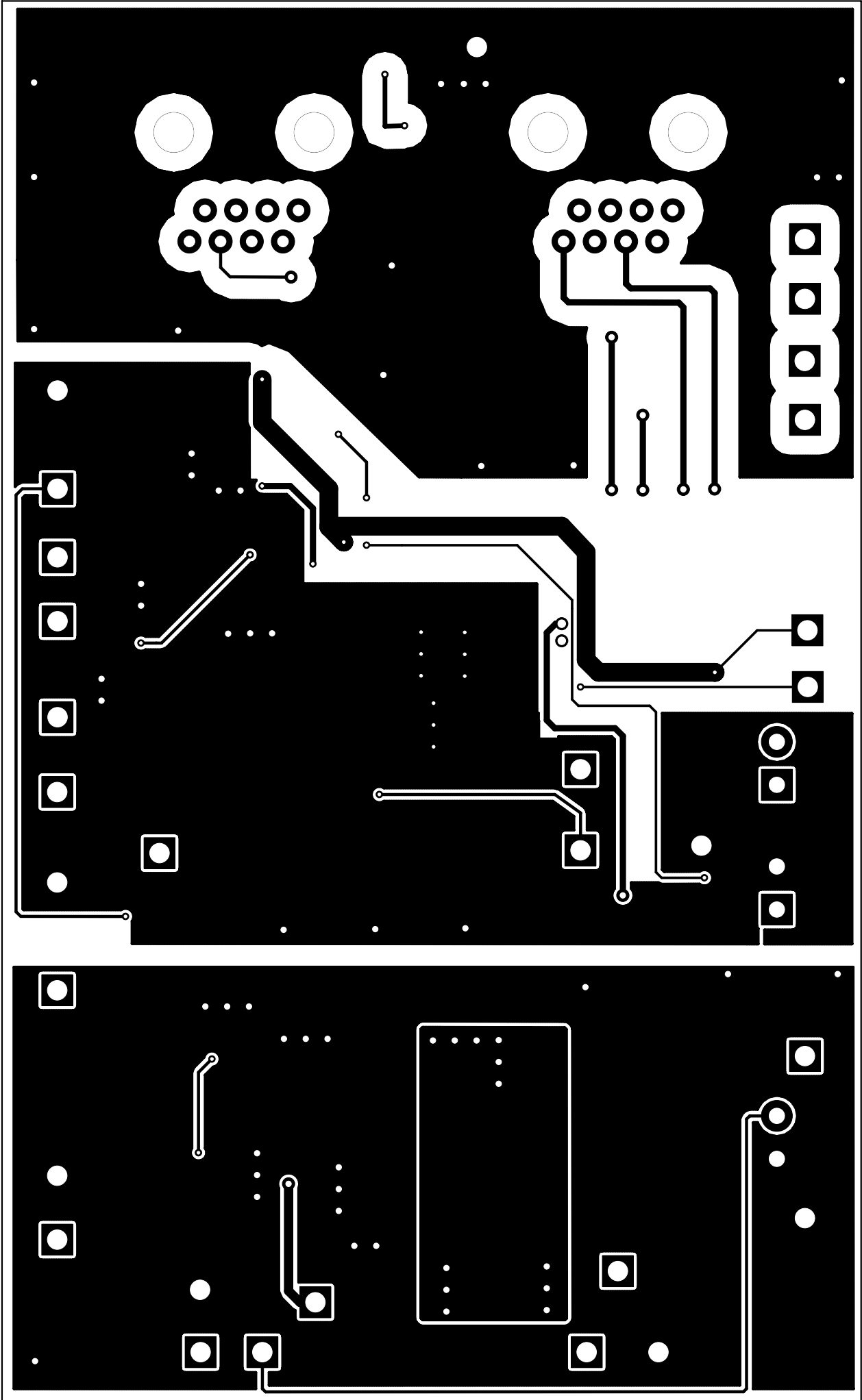
11



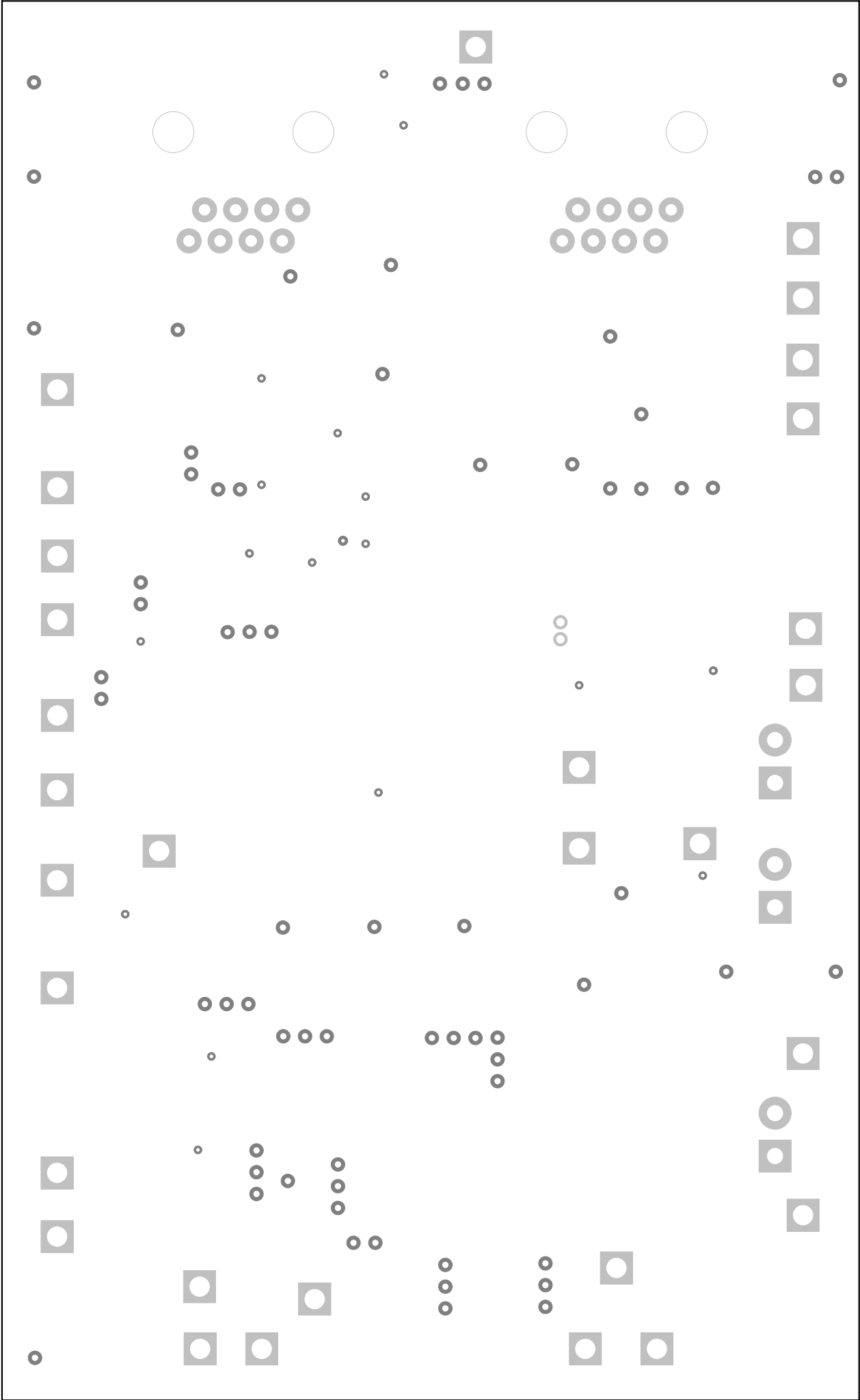
M1



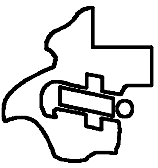




L2



M2



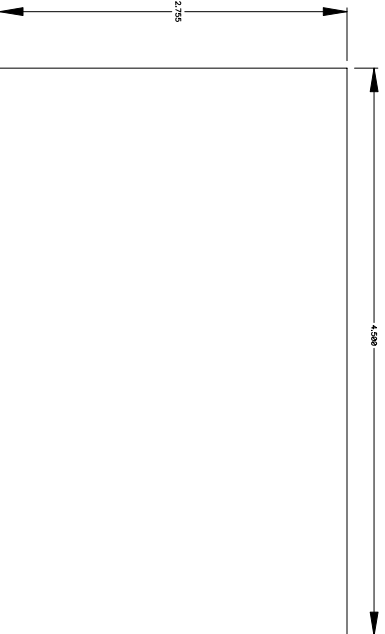
TEXAS INSTRUMENTS
TPS23753EVM-003
TPS23753EVM-004
TPS23753EVM-005
HPA305 Rev. A

FABRICATION CHART

FINISHED THICKNESS	SILKSCREEN	SOLDERMASK	FINISHED COPPER WEIGHT
<input type="checkbox"/> 0.031	<input checked="" type="checkbox"/> LAYER 1	<input checked="" type="checkbox"/> LAYER 1	<input type="checkbox"/> 1 OZ.
<input checked="" type="checkbox"/> 0.062	<input checked="" type="checkbox"/> LAYER 2	<input checked="" type="checkbox"/> LAYER 2	<input checked="" type="checkbox"/> 2 OZ.
<input type="checkbox"/> 0.093	<input type="checkbox"/> NONE	<input type="checkbox"/> NONE	<input type="checkbox"/> OTHER _____
<input type="checkbox"/> 0.125			
DESIGN	TRACE/GAP SPACING	LAYER COUNT	
<input type="checkbox"/> SMD	<input type="checkbox"/> 0.010/0.010	<input type="checkbox"/> SINGLE SIDED	
<input type="checkbox"/> THRU-HOLE	<input type="checkbox"/> 0.008/0.007	<input checked="" type="checkbox"/> 2 LAYER	
<input checked="" type="checkbox"/> MIX	<input checked="" type="checkbox"/> 0.006/0.006	<input type="checkbox"/> 4 LAYER	
		<input type="checkbox"/> OTHER _____	

NOTES: UNLESS OTHERWISE SPECIFIED

- MATERIAL:** ALL MATERIALS, INCLUDING BUT NOT LIMITED TO BASE LAMINATE, BONDING MATERIALS AND SOLDERMASK COATINGS FORMING THE FINISHED PRINTED CIRCUIT BOARD SHALL MEET UL-796 REQUIREMENTS AND HAVE A FLAMMABILITY OF UL94V-0.
PLASTIC SHEET LAMINATED METAL CLAD, TWO SIDES, BASE MATERIAL NEMA TYPE FR-4
GLASS EPOXY RESIN, COPPER-CLAD IN ACCORDANCE WITH 2 LAYER STACK-UP.
SOLDERMASK OVER BARE COPPER (SMOBC) USING LIQUID PHOTO-IMAGEABLE SOLDERMASK IN ACCORDANCE WITH IPC-SM-840.
- BASE LAMINATE:** HOLES REQUIRING PLATING, SEE HOLE CHART, TO HAVE 1 OZ. (0.0014) MIN. THK MIN. THICK COPPER.
- SOLDERMASK:** SOLDER COAT, SN63, PB37, RMA FLUX, 0.0005" +/- 0.0005" THICK ALL EXPOSED AREAS AS COATED, NO ACTIVE FLUXES ARE ACCEPTABLE.
- PLATING:** IF REQUIRED, SILKSCREEN LEGEND(S) WITH WHITE NON-CONDUCTIVE EPOXY INK. BOARD MUST BEAR VENDOR'S IDENTIFICATION CODE (ETCH OR WHITE NON-CONDUCTIVE INK). LOCATION OPTIONAL.
- FINISH:** BOARD IS TO BE MANUFACTURED PER IPC-A-600 CLASS 2 REQUIREMENTS OR BETTER.
- LEGEND:**
- MARKINGS:**
- WORKMANSHIP:**
- PCB VENDOR IS REQUIRED TO RETURN ANY AND ALL DOCUMENTS SUPPLIED OR ULTIMATELY PURCHASED BY TEXAS INSTRUMENTS UPON COMPLETION OF PURCHASE ORDER.**
- DRILL SIZES:** HOLE DIAMETERS SHOWN ARE FINISHED SIZES AFTER PLATING.
- PANEL BORDER:** ANY METAL IN BORDER AREA INCLUDING PART NUMBER, DATECODE AND/OR REVISION LETTERS MUST BE COVERED WITH SOLDERMASK.
- NO DIMENSIONAL, MATERIAL, OR PROCESS CHANGES ARE ALLOWED WITHOUT PRIOR EXPLICIT WRITTEN PERMISSION FROM TEXAS INSTRUMENTS.**



Hole Dia (inch)	Symbol	Quantity	Plated
0.010	+	31	Yes
0.018	X	67	Yes
0.025	Y	2	Yes
0.035	T	16	Yes
0.050	Z	6	Yes
0.053	M	30	Yes
0.128	□	4	No

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